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Texas Instruments
CALVCH16245IDLREP

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Datasheet of CALVCH16245IDLREP - IC BUS TXRX 16BIT 3-ST 48-SSOP

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SN74ALVCH16245-EP 16-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES608A-SEPTEMBER 2004-REVISED JUNE 2006

FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Member of the Texas Instruments Widebus™
 Family
- Operates From 1.65 V to 3.6 V
- Max t_{pd} of 3 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

(TOP VIEW)								
1DIR [1B1 [1B2 [GND [1B3 [1B4 [Vcc [1B5 [GND [1B7 [2B1 [2B2 [GND [2B3 [2B4 [Vcc [2B5 [TOP VIII 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19	48 47 46 45 44 43 42 41 40 39 38 37 36 35 34 33 32 31 30	10E 1A1 1A2 GND 1A3 1A4 Vcc 1A5 1A6 GND 1A7 1A8 2A1 2A2 GND 2A3 2A4 Vcc 2A5					
2B4	18	32	2A4					
2B5 [2B6 [19 20	30 29	2A5 2A6					
GND [2B7 [2B8 [2DIR [21 22 23 24	28 27 26 25	GND 2A7 2A8 2 OE					

DL PACKAGE

DESCRIPTION/ORDERING INFORMATION

This 16-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74ALVCH16245-EP is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated.

ORDERING INFORMATION

T _A	PACKA	GE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	SSOP - DL	Tape and reel	CALVCH16245IDLREP	ALVCH16245
-55°C to 125°C	SSOP - DL	Tape and reel	CALVCH16245MDLREP	ALCH16245M

 Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

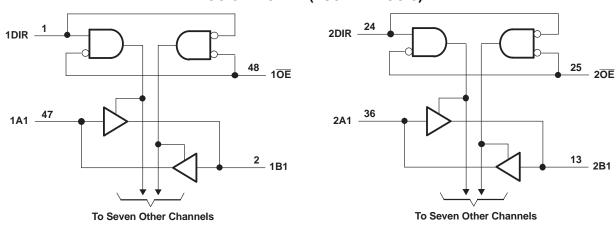
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	ODEDATION
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIM	I MAX	UNIT
V _{CC}	V _{CC} Supply voltage range				V
.,	land to alta a a mana	Except I/O ports ⁽²⁾	-0.5	5 4.6	
VI	Input voltage range	I/O ports ⁽²⁾⁽³⁾	-0.5	V _{CC} + 0.5	V
Vo	Output voltage range (2)(3)	·	-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		- 50	mA
I _{OK}	Output clamp current	V _O < 0		- 50	mA
Io	Continuous output current			±50	mA
	Continuous current through each V _{CC} or	GND		±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾			63	°C/W
T _{stg}	Storage temperature range		-65	5 150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ This value is limited to 4.6 V maximum.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



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SCES608A-SEPTEMBER 2004-REVISED JUNE 2006

Recommended Operating Conditions(1)

			MIN	MAX	UNIT
V_{CC}	Supply voltage		1.65	3.6	V
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
V_{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V
		V _{CC} = 2.7 V to 3.6 V		0.8	
V _I	Input voltage	0	V _{CC}	V	
Vo	Output voltage		0	V _{CC}	V
		V _{CC} = 1.65 V		-4	
	High lovel output overent	V _{CC} = 2.3 V		-12	A
I _{OH}	igh-level output current V _{CC} = 2.7 V			-12	mA
		V _{CC} = 3 V		-24	
		V _{CC} = 1.65 V		4	
	Law level autout aurent	V _{CC} = 2.3 V		12	A
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12	mA
	V _{CC} = 3 V			24	
Δt/Δν	Input transition rise or fall rate	·		10	ns/V
T _A	Operating free-air temperature (I temp)		-40	85	°C
T _A	Operating free-air temperature (M temp)		-55	125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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SCES608A-SEPTEMBER 2004-REVISED JUNE 2006

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{cc}	MIN	TYP ⁽¹⁾ MAX	UNIT	
	$I_{OH} = -100 \mu\text{A}$	1.65 V to 3.6 V	V _{CC} - 0.2			
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2			
	$I_{OH} = -6 \text{ mA}$	2.3 V	2			
V _{OH}		2.3 V	1.7		V	
	$I_{OH} = -12 \text{ mA}$	2.7 V	2.2			
		3 V	2.4			
	$I_{OH} = -24 \text{ mA}$	3 V	2			
	$I_{OL} = 100 \mu A$	1.65 V to 3.6 V		0.2		
	I _{OL} = 4 mA	1.65 V		0.45		
V	I _{OL} = 6 mA	2.3 V		0.4	\/	
V _{OL}	L - 12 mA	2.3 V		0.7	V	
	I _{OL} = 12 mA	2.7 V		0.4		
	I _{OL} = 24 mA	3 V		0.55		
I _I	$V_{I} = V_{CC}$ or GND	3.6 V		±5	μΑ	
	V _I = 0.58 V	1.65 V	25			
	V _I = 1.07 V	1.65 V	-25			
	$V_{I} = 0.7 \text{ V}$	2.3 V	45			
I _{I(hold)}	V _I = 1.7 V	2.3 V	-45		μΑ	
	V _I = 0.8 V	3 V	75			
	V _I = 2 V	3 V	-75			
	$V_1 = 0$ to 3.6 $V^{(2)}$	3.6 V		±500		
I _{OZ} ⁽³⁾	$V_O = V_{CC}$ or GND	3.6 V		±10	μΑ	
I _{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V		40	μΑ	
Δl _{CC}	One input at $V_{CC} - 0.6 \text{ V}$, Other inputs at V_{CC} or GND	3 V to 3.6 V		750	μΑ	
C _i Control inputs	V _I = V _{CC} or GND	3.3 V		4	pF	
C _{io} A or B port	$V_O = V_{CC}$ or GND	3.3 V		8	pF	

Switching Characteristics

over recommended operating free-air I temperature (-40°C to 85°C) range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO	⊥ 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3 ± 0.3	UNIT	
	(INPUT)	(OUTPUT)	MIN	MIN MAX		MAX	MIN	MIN MAX	
t _{pd}	A or B	B or A	1	3.7		3.6	1	3	ns
t _{en}	ŌĒ	A or B	1	5.7		5.4	1	4.4	ns
t _{dis}	ŌĒ	A or B	1	5.2		4.6	1	4.1	ns

All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

For I/O ports, the parameter I_{OZ} includes the input leakage current.



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Switching Characteristics

over recommended operating free-air M temperature (-55°C to 125°C) range (unless otherwise noted) (see Figure 1)

PARAMETER	PARAMETER FROM TO		METER FROM TO (INPUT) (OUTPUT)		V_{CC} = 2.5 V \pm 0.2 V		V_{CC} = 3.3 V \pm 0.3 V		UNIT
	(INPOT)	(001701)	MIN	MAX	MIN	MAX			
t _{pd}	A or B	B or A	1	4.5	1	4.0	ns		
t _{en}	ŌĒ	A or B	1	8.2	1	5.5	ns		
t _{dis}	ŌĒ	A or B	1	7.5	1	5.0	ns		

Operating Characteristics

 $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT
C Power dissipation conscitance	Outputs enabled	C ₁ = 50 pF. f = 10 MH	(1)	22	29	PF
C _{pd} Power dissipation capacitance	Outputs disabled	$C_L = 50 \text{ pr}, \Gamma = 10 \text{ With}$	(1)	4	5	рг

(1) This information was not available at the time of publication.



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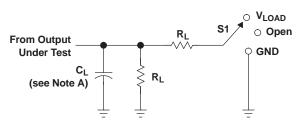
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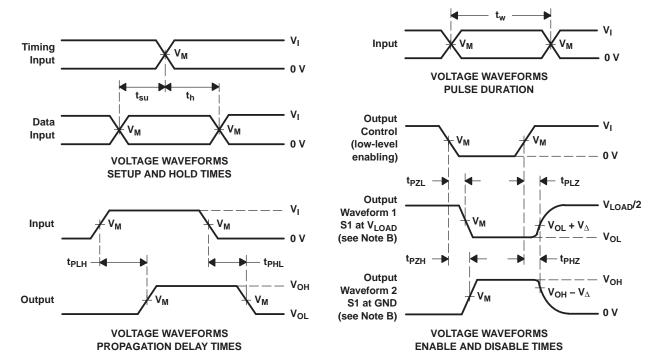
PARAMETER MEASUREMENT INFORMATION



TEST	S1
t _{pd}	Open
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND

LOAD CIRCUIT

V	IN	PUT	V	V		В	V
V _{CC}	VI	t _r /t _f	V _M	V _{LOAD}	CL	R _L	V_{Δ}
1.8 V	V _{CC}	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	V _{CC}	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_0 = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGE OPTION ADDENDUM

22-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
8R16245MDLREPG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CALVCH16245IDLREP	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CALVCH16245MDLREP	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04763-01XE	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04763-02XE	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74ALVCH16245-EP:

Catalog: SN74ALVCH16245

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

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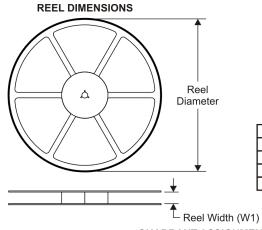
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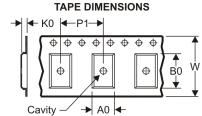


PACKAGE MATERIALS INFORMATION

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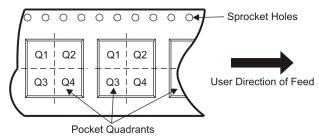
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CALVCH16245IDLREP	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1
CALVCH16245MDLREP	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

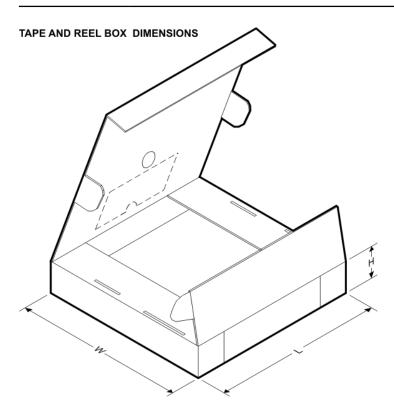
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PACKAGE MATERIALS INFORMATION

5-Aug-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CALVCH16245IDLREP	SSOP	DL	48	1000	346.0	346.0	49.0
CALVCH16245MDLREP	SSOP	DL	48	1000	346.0	346.0	49.0



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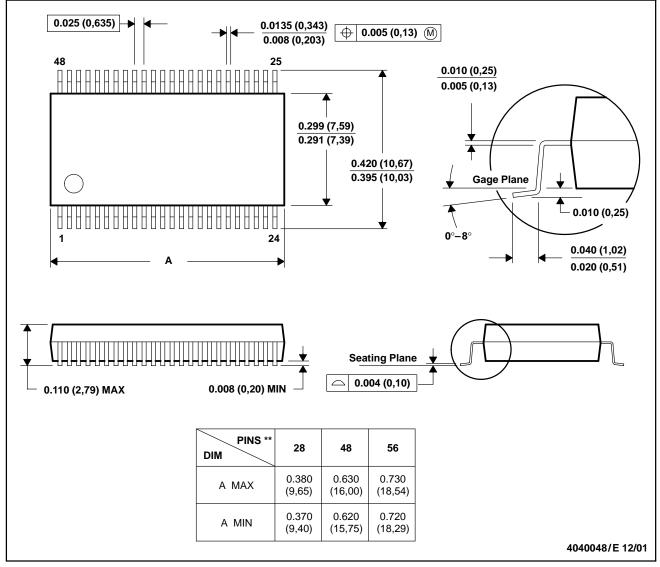
MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118





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